

TOSHIBA Photocoupler GaAs Ired &amp; Photo-Transistor

**TLP331,TLP332**

Office Machine

Household Use Equipment

Programmable Controllers

AC / DC-Input Module

Telecommunication

The TOSHIBA TLP331 and TLP332 consists of a gallium arsenide infrared emitting diode optically coupled to a photo-transistor in a six lead plastic DIP package.

This photocoupler provides the unique feature of high current transfer ratio at both low output voltage and low input current. This makes it ideal for use in low power logic circuits, telecommunications equipment and portable electronics isolation applications.

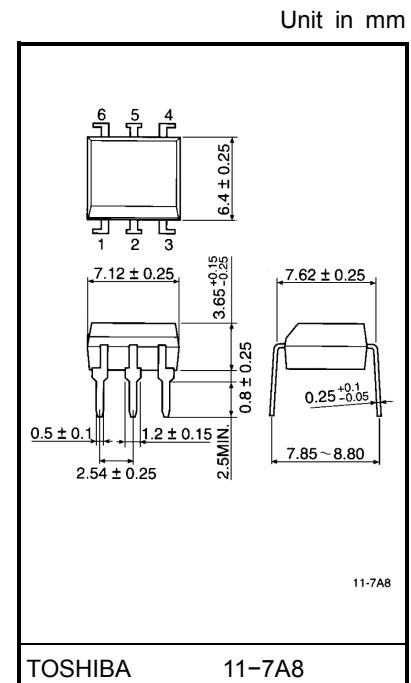
TLP332 is no-base internal connection for high-EMI environments.

- Collector-emitter voltage: 55V (min.)
- Isolation voltage: 5000Vrms (min.)
- UL recognized: UL1577, file no. E67349
- Current transfer ratio

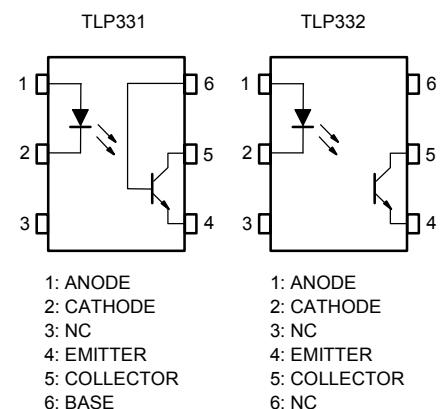
Classifi- cation (*)	Current Transfer Ratio (min.)			Marking Of Classifi- cation
	Ta = 25°C		Ta = -25~75°C	
	I <sub>F</sub> = 1mA V <sub>CE</sub> = 0.5V	I <sub>F</sub> = 0.5mA V <sub>CE</sub> = 1.5V	I <sub>F</sub> = 1mA V <sub>CE</sub> = 0.5V	
Rank BV	200%	100%	100%	BV
Standard	100%	50%	50%	BV, blank

(\*) Ex. Standard: TLP331  
Rank BV: TLP331(BV)

(Note) Application type name for certification test,  
please use standard product type name, i.e.  
TLP331(BV): TLP331



Weight: 0.4 g

**Pin Configurations (top view)**

**Maximum Ratings (Ta = 25°C)**

Characteristic		Symbol	Rating	Unit	
LED	Forward current	I <sub>F</sub>	50	mA	
	Forward current derating (Ta ≥ 39°C)	ΔI <sub>F</sub> /°C	-0.7	mA / °C	
	Peak forward current (100μs pulse, 100pps)	I <sub>FP</sub>	1	A	
	Reverse Voltage	V <sub>R</sub>	5	V	
	Junction temperature	T <sub>j</sub>	125	°C	
Detector	Collector-emitter voltage	V <sub>CEO</sub>	55	V	
	Collector-base voltage (TLP331)	V <sub>CBO</sub>	80	V	
	Emitter-collector voltage	V <sub>ECO</sub>	7	V	
	Emitter-base voltage (TLP331)	V <sub>EBO</sub>	7	V	
	Collector current	I <sub>C</sub>	50	mA	
	Power dissipation	P <sub>C</sub>	150	mW	
	Power dissipation derating (Ta ≥ 25°C)	ΔP <sub>C</sub> / °C	-1.5	mW / °C	
	Junction temperature	T <sub>j</sub>	125	°C	
Storage temperature range		T <sub>stg</sub>	-55~125	°C	
Operating temperature range		T <sub>opr</sub>	-55~100	°C	
Lead soldering temperature (10s)		T <sub>sol</sub>	260	°C	
Total package power dissipation		P <sub>T</sub>	250	mW	
Total package power dissipation derating (Ta≥25°C)		P <sub>T</sub> /°C	-2.5	mW / °C	
Isolation voltage (AC, 1min., RH ≤ 60%)		(Note 1)	BV <sub>S</sub>	5000	V <sub>rms</sub>

(Note 1) Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4, 5 and 6 shorted together.

**Recommended Operating Conditions**

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V <sub>CC</sub>	—	5	25	V
Forward current	I <sub>F</sub>	—	1.6	25	mA
Collector current	I <sub>C</sub>	—	1	10	mA
Operating temperature	T <sub>opr</sub>	-25	—	75	°C

**Individual Electrical Characteristics (Ta = 25°C)**

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
LED	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5V	—	—	10	µA
	Capacitance	C <sub>T</sub>	V = 0, f = 1MHz	—	30	—	pF
Detector	Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = 0.5mA	55	—	—	V
	Emitter-collector breakdown voltage	V <sub>(BR)ECO</sub>	I <sub>E</sub> = 0.1mA	7	—	—	V
	Collector-base breakdown voltage (TLP331)	V <sub>(BR)CBO</sub>	I <sub>C</sub> = 0.1mA	80	—	—	V
	Emitter-base breakdown voltage (TLP331)	V <sub>(BR)EBO</sub>	I <sub>E</sub> = 0.1mA	7	—	—	V
	Collector dark current	I <sub>CEO</sub>	V <sub>CE</sub> = 24V	—	10	100	nA
			V <sub>CE</sub> = 24V, Ta = 85°C	—	2	50	µA
	Collector dark current (TLP331)	I <sub>CER</sub>	V <sub>CE</sub> = 24V, Ta = 85°C R <sub>BE</sub> = 1MΩ	—	0.5	10	µA
	Collector dark current (TLP331)	I <sub>CBO</sub>	V <sub>CB</sub> = 10V	—	0.1	—	nA
	DC forward current gain (TLP331)	h <sub>FE</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> = 0.5mA	—	1000	—	—
Capacitance (collector to emitter)		C <sub>CE</sub>	V = 0, f = 1MHz	—	12	—	pF

**Coupled Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Current transfer ratio	I <sub>C</sub> / I <sub>F</sub>	I <sub>F</sub> = 1mA, V <sub>CE</sub> = 0.5V Rank BV	100	—	1200	%
			200	—	1200	
Low input CTR	I <sub>C</sub> / I <sub>F(low)</sub>	I <sub>F</sub> = 0.5mA, V <sub>CE</sub> = 1.5V Rank BV	50	—	—	%
			100	—	—	
Base photo-current (TLP331)	I <sub>PB</sub>	I <sub>F</sub> = 1mA, V <sub>CB</sub> = 5V	—	10	—	µA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 0.5mA I <sub>F</sub> = 1mA	—	—	0.4	V
		I <sub>C</sub> = 1mA I <sub>F</sub> = 1mA Rank BV	—	0.2	—	
		—	—	0.4	—	

**Coupled Electrical Characteristics (Ta = 25~75°C)**

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Current transfer ratio	I <sub>C</sub> / I <sub>F</sub>	I <sub>F</sub> = 1mA, V <sub>CE</sub> = 0.5V Rank BV	50	—	—	%
			100	—	—	
Low input CTR	I <sub>C</sub> / I <sub>F(low)</sub>	I <sub>F</sub> = 0.5mA, V <sub>CE</sub> = 1.5V Rank BV	—	50	—	%
			—	100	—	

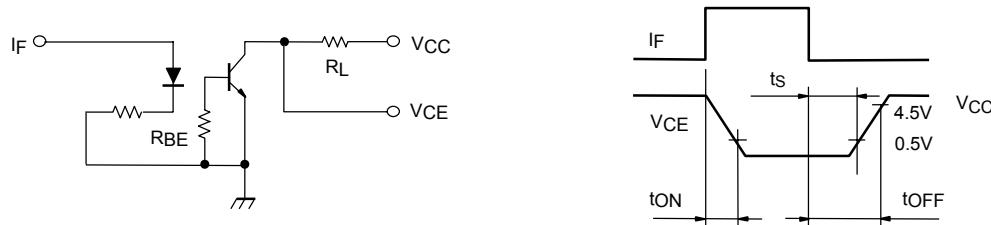
**Isolation Characteristics (Ta = 25°C)**

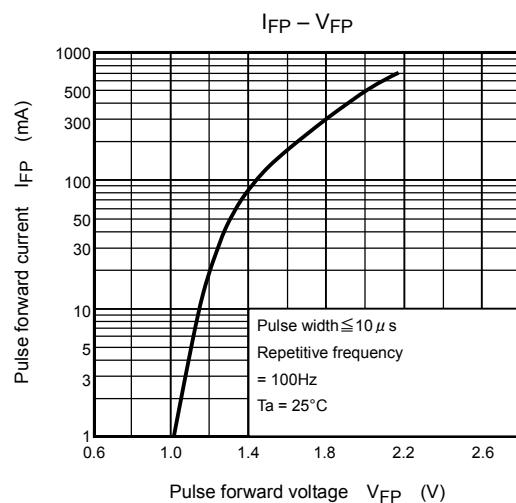
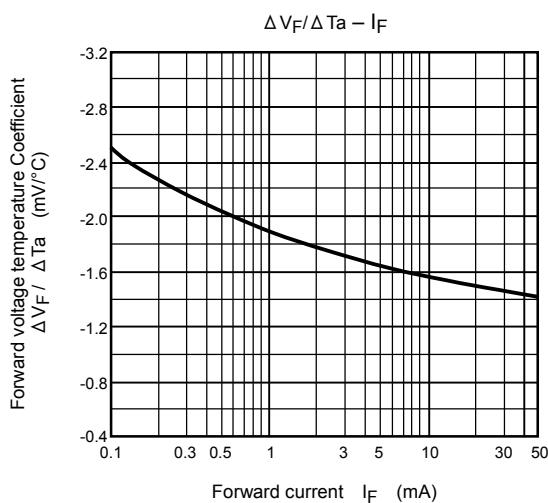
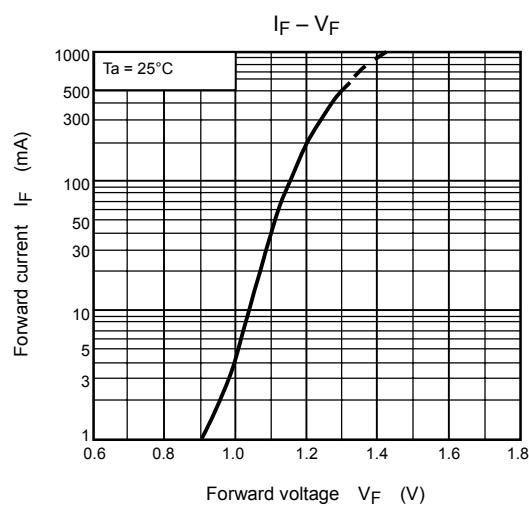
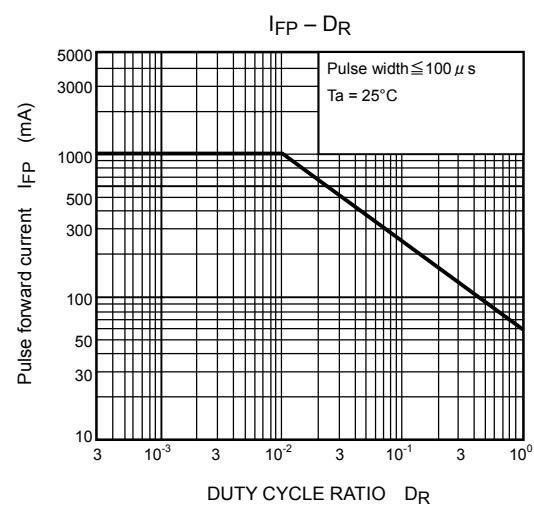
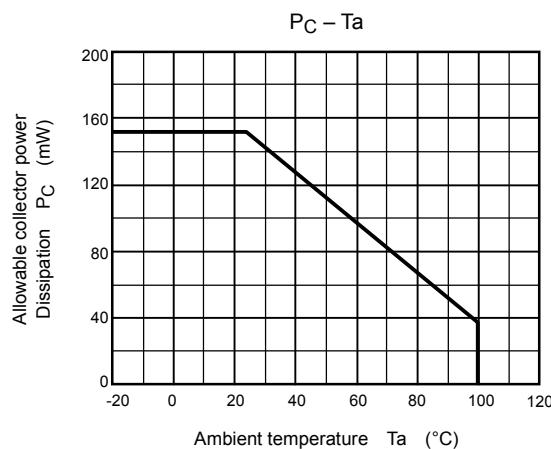
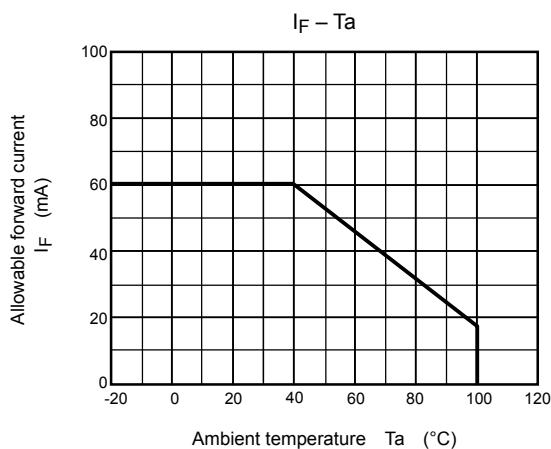
Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Capacitance (input to output)	C <sub>S</sub>	V <sub>S</sub> = 0, f = 1MHz	—	0.8	—	pF
Isolation resistance	R <sub>S</sub>	V = 500V	5×10 <sup>10</sup>	10 <sup>14</sup>	—	Ω
Isolation voltage	BV <sub>S</sub>	AC, 1 minute	5000	—	—	V <sub>rms</sub>
		AC, 1 second, in oil	—	10000	—	
		DC, 1 minute, in oil	—	10000	—	V <sub>dc</sub>

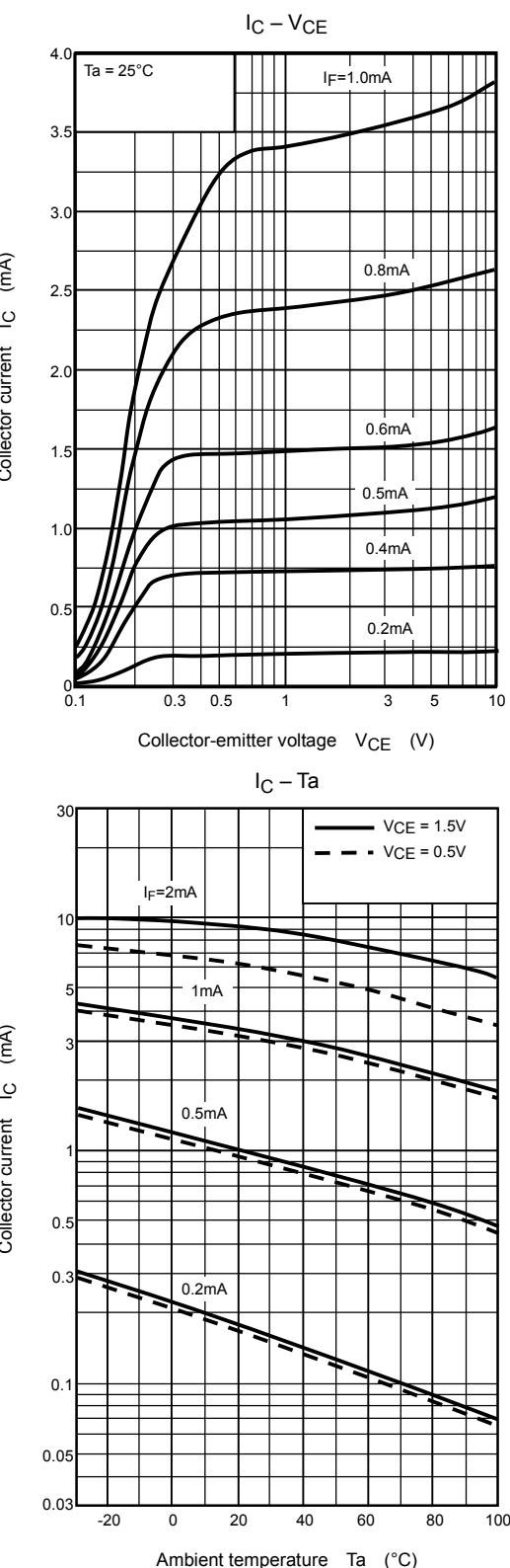
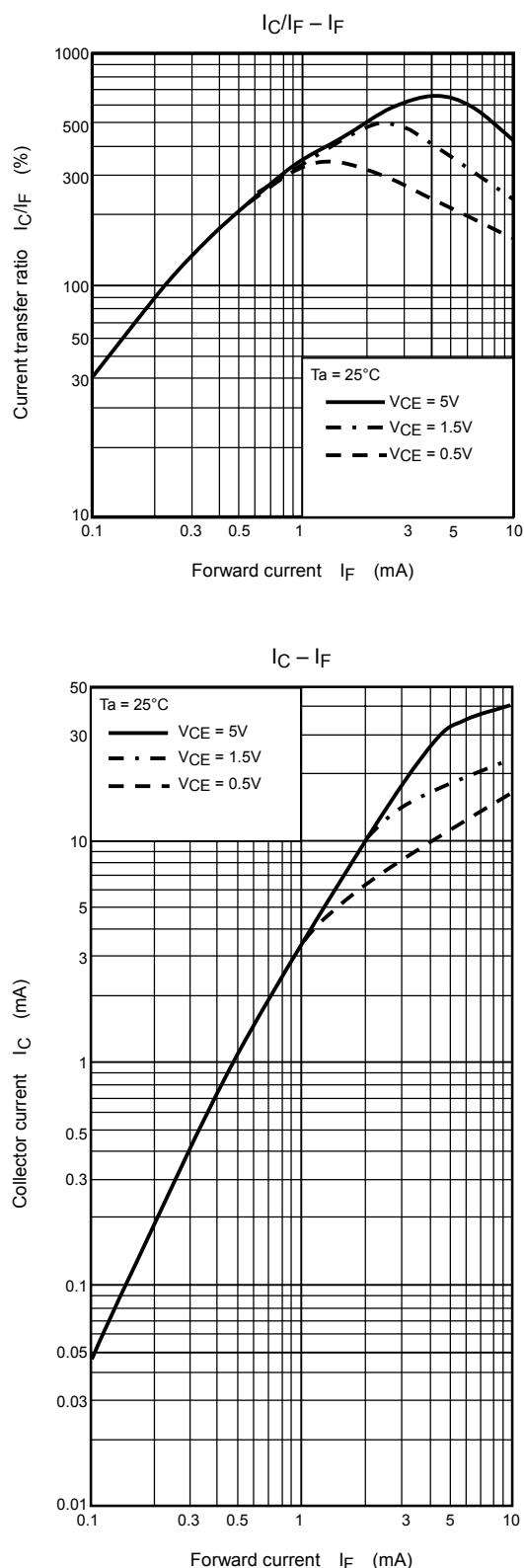
**Switching Characteristics (Ta = 25°C)**

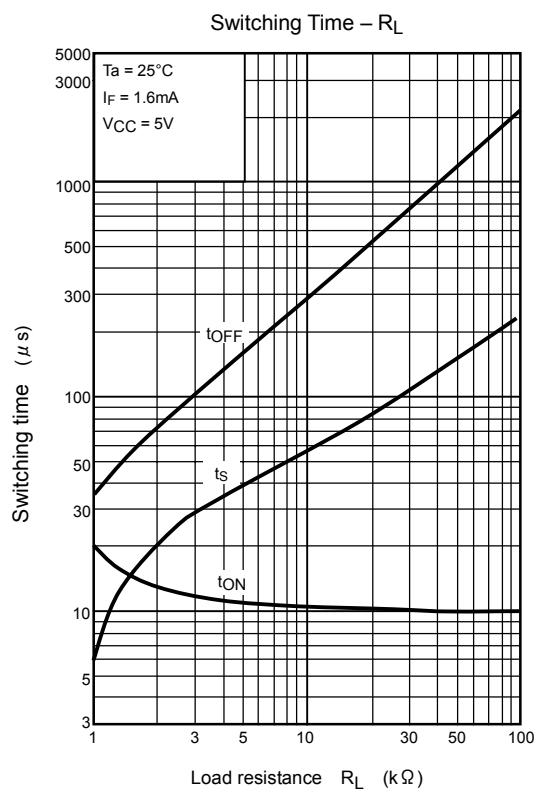
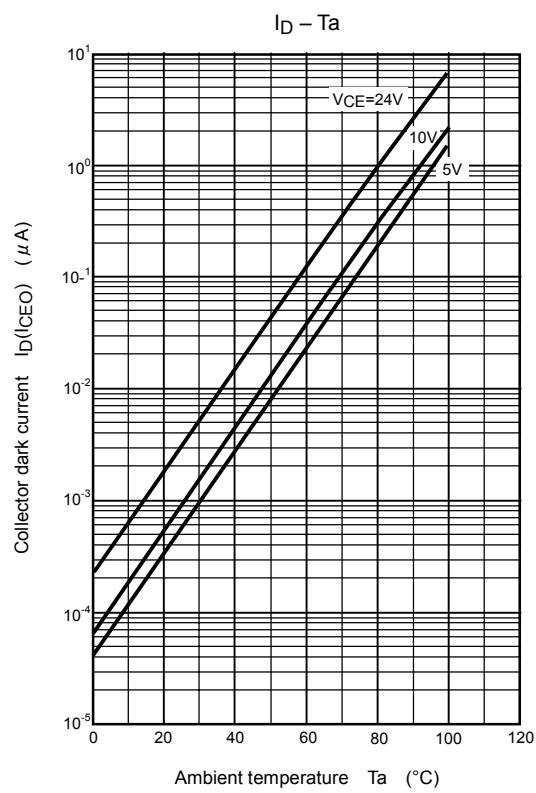
Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Rise time	t <sub>r</sub>	V <sub>CC</sub> = 10V I <sub>C</sub> = 2mA R <sub>L</sub> = 100Ω	—	8	—	μs
Fall time	t <sub>f</sub>		—	8	—	
Turn-on time	t <sub>on</sub>		—	10	—	
Turn-off time	t <sub>off</sub>		—	8	—	
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> = 4.7kΩ (Fig.1) R <sub>BE</sub> = OPEN V <sub>CC</sub> = 5V, I <sub>F</sub> = 1.6mA	—	10	—	μs
Storage time	t <sub>S</sub>		—	50	—	
Turn-off time	t <sub>OFF</sub>		—	300	—	
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> = 4.7kΩ (Fig.1) R <sub>BE</sub> = 470kΩ (TLP331) V <sub>CC</sub> = 5V, I <sub>F</sub> = 1.6mA	—	12	—	μs
Storage time	t <sub>S</sub>		—	30	—	
Turn-off time	t <sub>OFF</sub>		—	100	—	

Fig. 1 Switching time test circuit









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